



**Invitation for Industry Mentors
Electrical Engineering, LeTourneau University**

The Department of Electrical Engineering at LeTourneau University invites you to become an industry mentor for 2021-2022 senior design project.

As an industry mentor, you have a great opportunity to provide your insight and expertise to bless our juniors and seniors who participate the senior design project. Your support and advise to our students help lead them to a successful completion of their project. With your help we can facilitate their academic growth and spiritual growth.

Currently, we are seeking for the mentors in the following areas:

- Electrical: RF, Communications, Mechatronics, PCB design, etc.
- Mechanical: Solidwork Design, Structure/Thermal analysis, waterproof, etc.
- Biomedical: Bio Instrumentation and device
- Computer: API, UI/UX, Machine Learning, etc.

If you are interested in this mentoring position, please, contact Dr. Hoo Kim(hookim@letu.edu), Assistant Professor of Electrical Engineering, at LeTourneau University. Please see the application form and confidential information agreement below. Please send these documents with your signature by Aug. 23rd. Please, provide your resume and brief introduction to your area to mentor as you follow the format in the next pages.

Industry mentor is a voluntary position, and all applicants may not be selected as mentors depending on the project needs and departmental situation. The selected mentor will serve our students in 2021-2022 academic year after receiving official mentor position.

*And in him you too are being built together
to become a dwelling in
which God lives by his Spirit.
Ephesians 2:22*

03/24/2021

Hoo Kim, Ph.D.
Assistant Professor
Electrical and Computer Engineering
School of Engineering & Engineering Technology
LeTourneau University

LeTu Senior Design Project Industry Mentor Application Form

Name	
Company/Org., Title	
Project you want to involve	
Specialty	
Graduate year (If you are LeTu alumni)	

I, _____, apply to this mentor position during 2021-2022 academic year.

Date: _____

Applicant Name: _____

Signature: _____